

## Class AB stereo headphone driver

**TDA1308**

### FEATURES

- Wide temperature range
- No switch ON/OFF clicks
- Excellent power supply ripple rejection
- Low power consumption
- Short-circuit resistant
- High performance
  - high signal-to-noise ratio
  - high slew rate
  - low distortion
- Large output voltage swing.

### GENERAL DESCRIPTION

The TDA1308 is an integrated class AB stereo headphone driver contained in an SO8 or a DIP8 plastic package. The device is fabricated in a 1 mm CMOS process and has been primarily developed for portable digital audio applications.

### QUICK REFERENCE DATA

$V_{DD} = 5\text{ V}$ ;  $V_{SS} = 0\text{ V}$ ;  $T_{amb} = 25\text{ }^{\circ}\text{C}$ ;  $f_i = 1\text{ kHz}$ ;  $R_L = 32\text{ }\Omega$ ; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{DD}$	supply voltage					
	single		3.0	5.0	7.0	V
	dual		1.5	2.5	3.5	V
$V_{SS}$	negative supply voltage		-1.5	-2.5	-3.5	V
$I_{DD}$	supply current	no load	–	3	5	mA
$P_{tot}$	total power dissipation	no load	–	15	25	mW
$P_o$	maximum output power	THD < 0.1%; note 1	–	60	–	mW
(THD + N)/S	total harmonic distortion plus noise-to-signal ratio	note 1				
			–	0.03	0.06	%
			–	-70	-65	dB
		$R_L = 5\text{ k}\Omega$	–	-101	–	dB
S/N	signal-to-noise ratio		100	110	–	dB
$\alpha_{cs}$	channel separation		–	70	–	dB
		$R_L = 5\text{ k}\Omega$	–	105	–	dB
PSRR	power supply ripple rejection	$f_i = 100\text{ Hz}$ ; $V_{ripple(p-p)} = 100\text{ mV}$	–	90	–	dB
$T_{amb}$	operating ambient temperature		-40	–	+85	$^{\circ}\text{C}$

### Note

1.  $V_{DD} = 5\text{ V}$ ;  $V_{O(p-p)} = 3.5\text{ V}$  (at 0 dB).

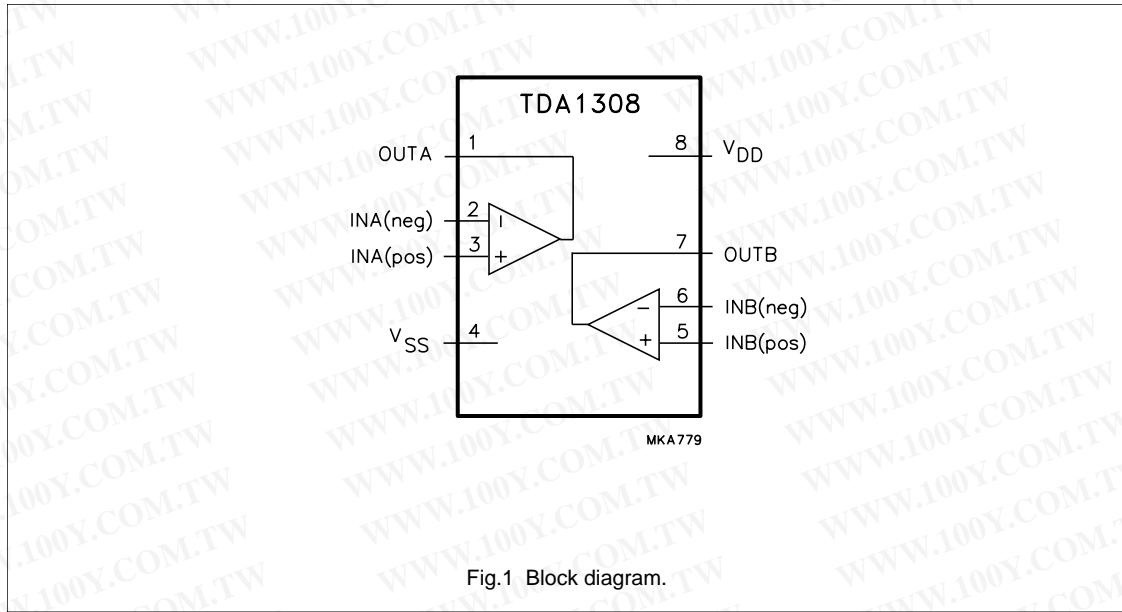
### ORDERING INFORMATION

TYPE NUMBER	PACKAGE		
	NAME	DESCRIPTION	VERSION
TDA1308	DIP8	plastic dual in-line package; 8 leads (300 mil)	SOT97-1
TDA1308T	SO8	plastic small outline package; 8 leads; body width 3.9 mm	SOT96-1

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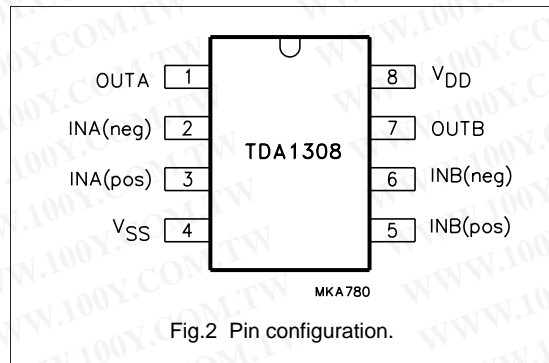
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BLOCK DIAGRAM



PINNING

SYMBOL	PIN	DESCRIPTION
OUTA	1	output A
INA(neg)	2	inverting input A
INA(pos)	3	non-inverting input A
V <sub>SS</sub>	4	negative supply
INB(pos)	5	non-inverting input B
INB(neg)	6	inverting input B
OUTB	7	output B
V <sub>DD</sub>	8	positive supply



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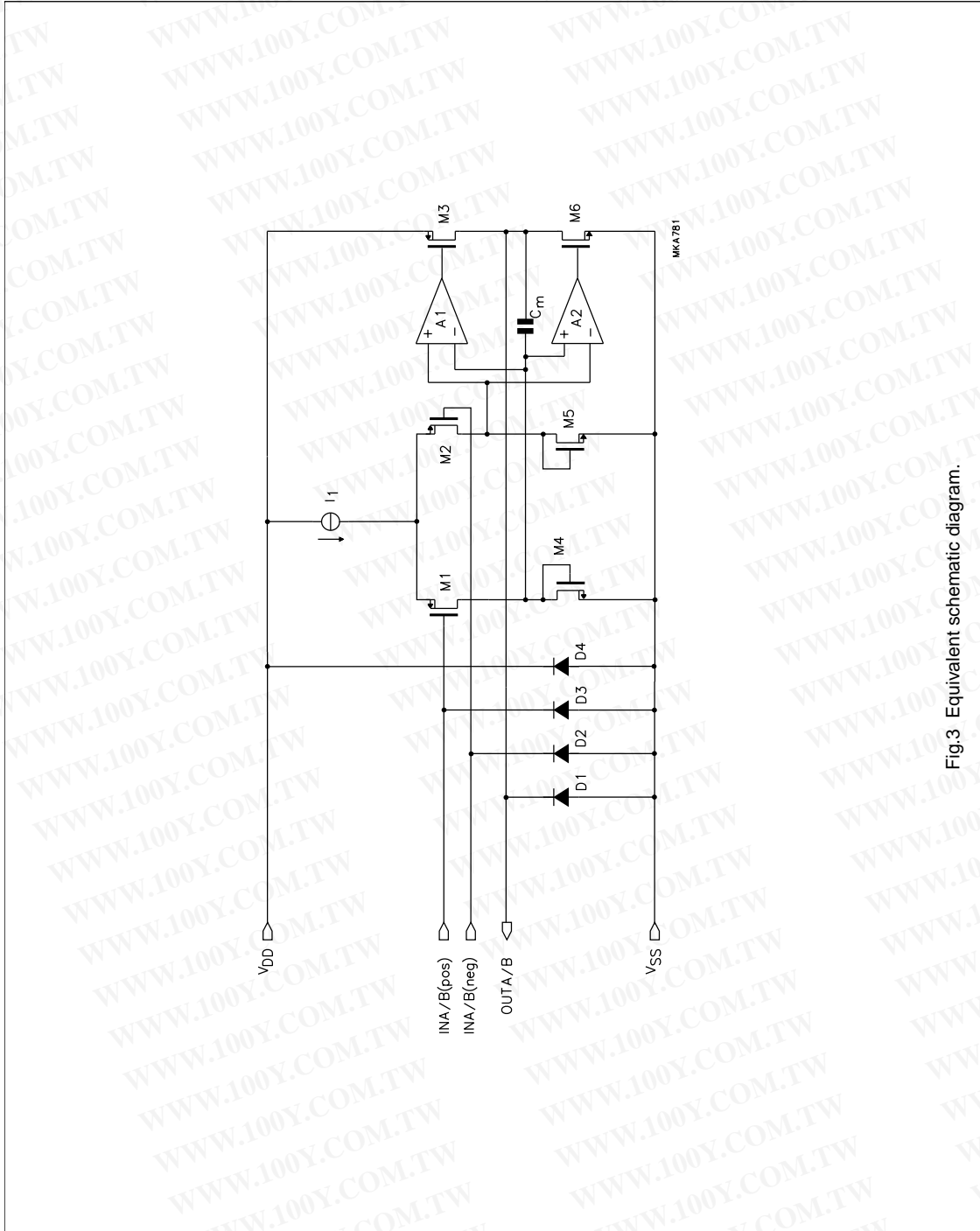


Fig.3 Equivalent schematic diagram.

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**LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{DD}$	supply voltage		0	8.0	V
$t_{SC(O)}$	output short-circuit duration	$T_{amb} = 25\text{ }^{\circ}\text{C}$ ; $P_{tot} = 1\text{ W}$	20	–	s
$T_{stg}$	storage temperature		–65	+150	$^{\circ}\text{C}$
$T_{amb}$	operating ambient temperature		–40	+85	$^{\circ}\text{C}$
$V_{esd}$	electrostatic discharge	note 1	–2000	+2000	V
		note 2	–200	+200	V

**Notes**

- Human body model:  $C = 100\text{ pF}$ ;  $R = 1500\text{ }\Omega$ ; 3 pulses positive plus 3 pulses negative.
- Machine model:  $C = 200\text{ pF}$ ;  $L = 0.5\text{ mH}$ ;  $R = 0\text{ }\Omega$ ; 3 pulses positive plus 3 pulses negative.

**THERMAL CHARACTERISTICS**

SYMBOL	PARAMETER	VALUE	UNIT
$R_{th\ j-a}$	thermal resistance from junction to ambient in free air		
	DIP8	109	K/W
	SO8	210	K/W

**QUALITY SPECIFICATION**

In accordance with "UZW-BO/FQ-0601". The numbers of the quality specification can be found in the "Quality Reference Handbook". The handbook can be ordered using the code 9398 510 63011.

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SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
<b>Supplies</b>						
$V_{DD}$	supply voltage					
	single		3.0	5.0	7.0	V
	dual		1.5	2.5	3.5	V
$V_{SS}$	negative supply voltage		-1.5	-2.5	-3.5	V
$I_{DD}$	supply current	no load	-	3	5	mA
$P_{\text{tot}}$	total power dissipation	no load	-	15	25	mW
<b>DC characteristics</b>						
$V_{I(\text{os})}$	input offset voltage		-	10	-	mV
$I_{\text{bias}}$	input bias current		-	10	-	pA
$V_{\text{CM}}$	common mode voltage		0	-	3.5	V
$G_v$	open-loop voltage gain	$R_L = 5\text{ k}\Omega$	-	70	-	dB
$I_O$	maximum output current	$(\text{THD} + \text{N})/\text{S} < 0.1\%$	-	60	-	mA
$R_O$	output resistance		-	0.25	-	$\Omega$
$V_O$	output voltage swing	note 1	0.75	-	4.25	V
		$R_L = 16\text{ }\Omega$ ; note 1	1.5	-	3.5	V
		$R_L = 5\text{ k}\Omega$ ; note 1	0.1	-	4.9	V
PSRR	power supply rejection ratio	$f_i = 100\text{ Hz}$ ; $V_{\text{ripple(p-p)}} = 100\text{ mV}$	-	90	-	dB
$\alpha_{\text{cs}}$	channel separation		-	70	-	dB
		$R_L = 5\text{ k}\Omega$	-	105	-	dB
$C_L$	load capacitance		-	-	200	pF
<b>AC characteristics</b>						
(THD + N)/S	total harmonic distortion plus noise-to-signal ratio	note 2	-	-70	-65	dB
			-	0.03	0.06	%
		note 2; $R_L = 5\text{ k}\Omega$	-	-101	-	dB
			-	0.0009	-	%
S/N	signal-to-noise ratio		100	110	-	dB
$f_G$	unity gain frequency	open-loop; $R_L = 5\text{ k}\Omega$	-	5.5	-	MHz
$P_o$	maximum output power	$(\text{THD} + \text{N})/\text{S} < 0.1\%$	-	60	-	mW
$C_i$	input capacitance		-	3	-	pF
SR	slew rate	unity gain inverting	-	5	-	V/ $\mu\text{s}$
B	power bandwidth	unity gain inverting	-	20	-	kHz

**Notes**

- Values are proportional to  $V_{DD}$ ;  $(\text{THD} + \text{N})/\text{S} < 0.1\%$ .
- $V_{DD} = 5.0\text{ V}$ ;  $V_{O(\text{p-p})} = 3.5\text{ V}$  (at 0 dB).

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TEST AND APPLICATION INFORMATION

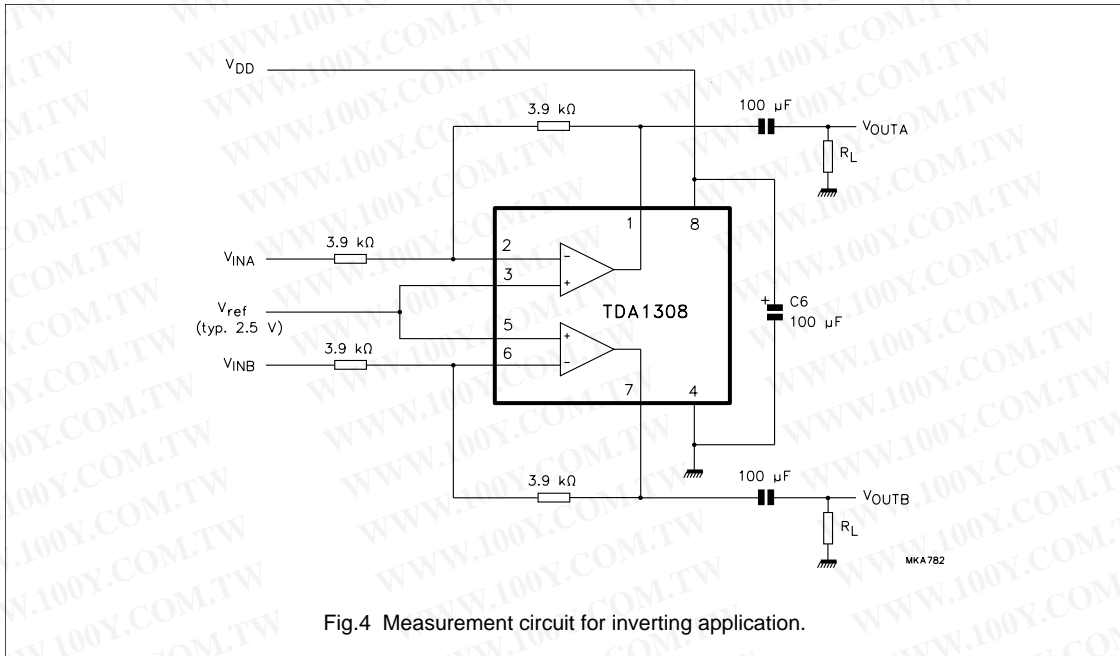


Fig.4 Measurement circuit for inverting application.

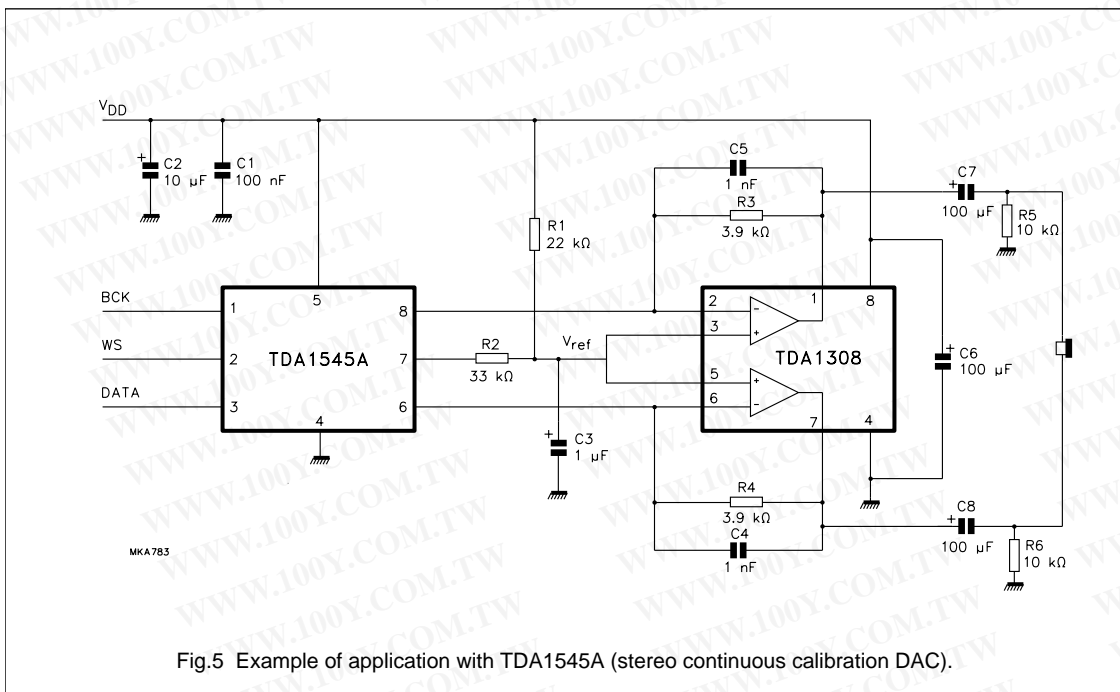
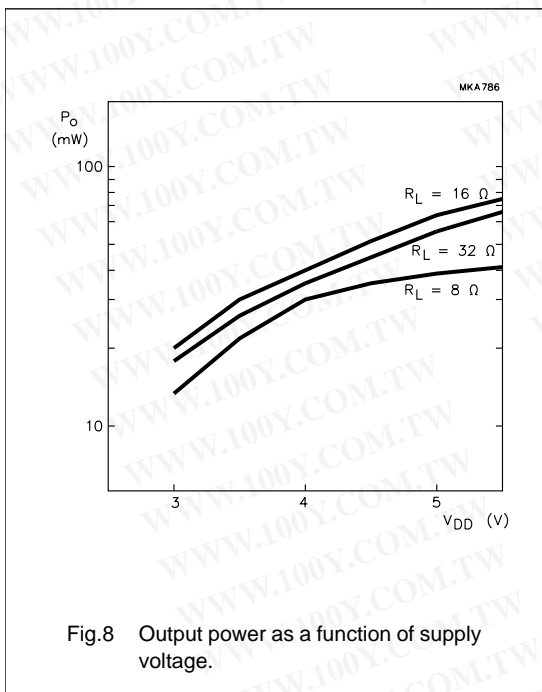
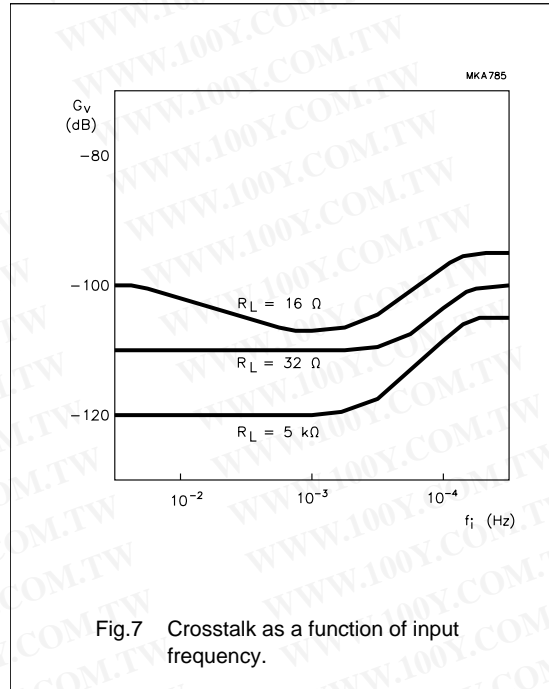
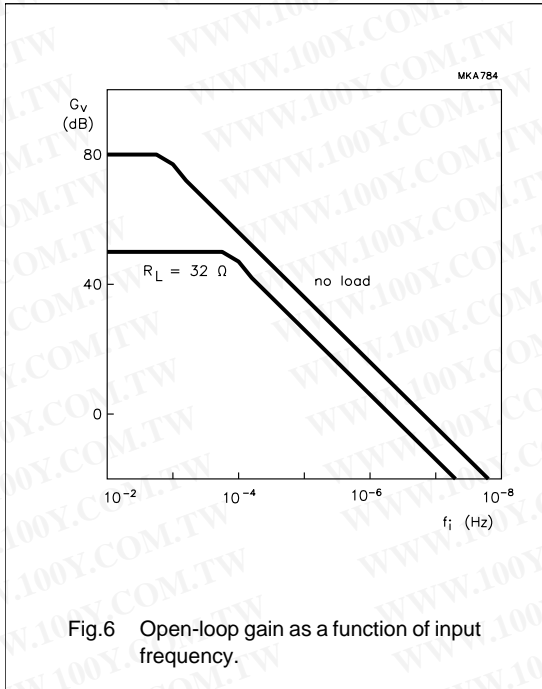


Fig.5 Example of application with TDA1545A (stereo continuous calibration DAC).

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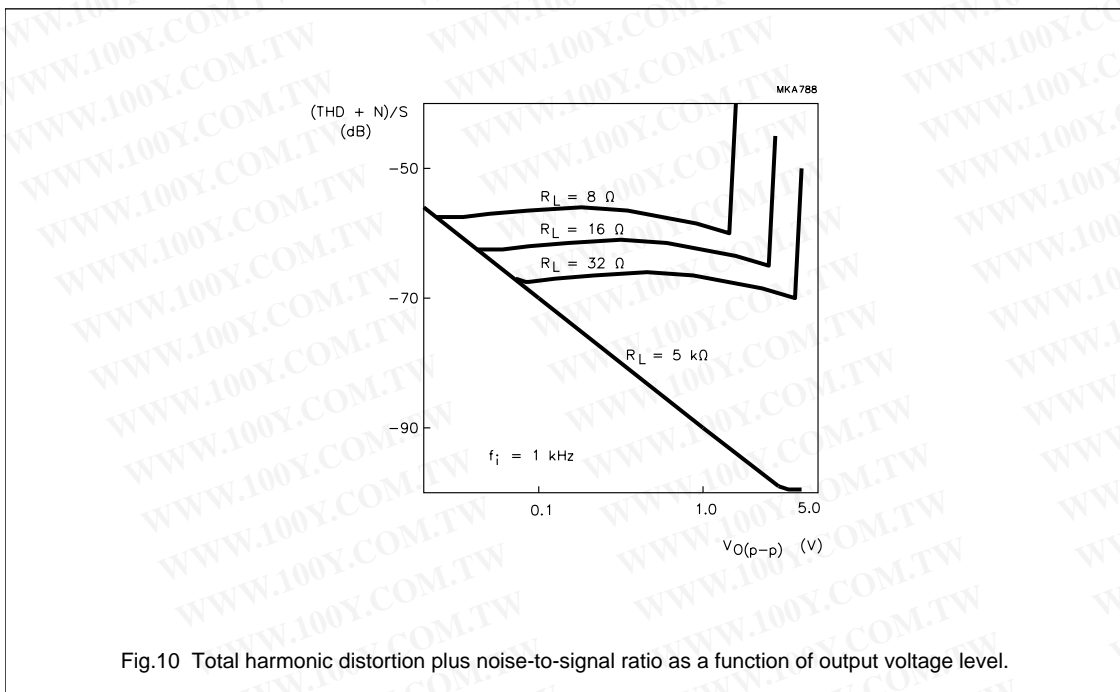
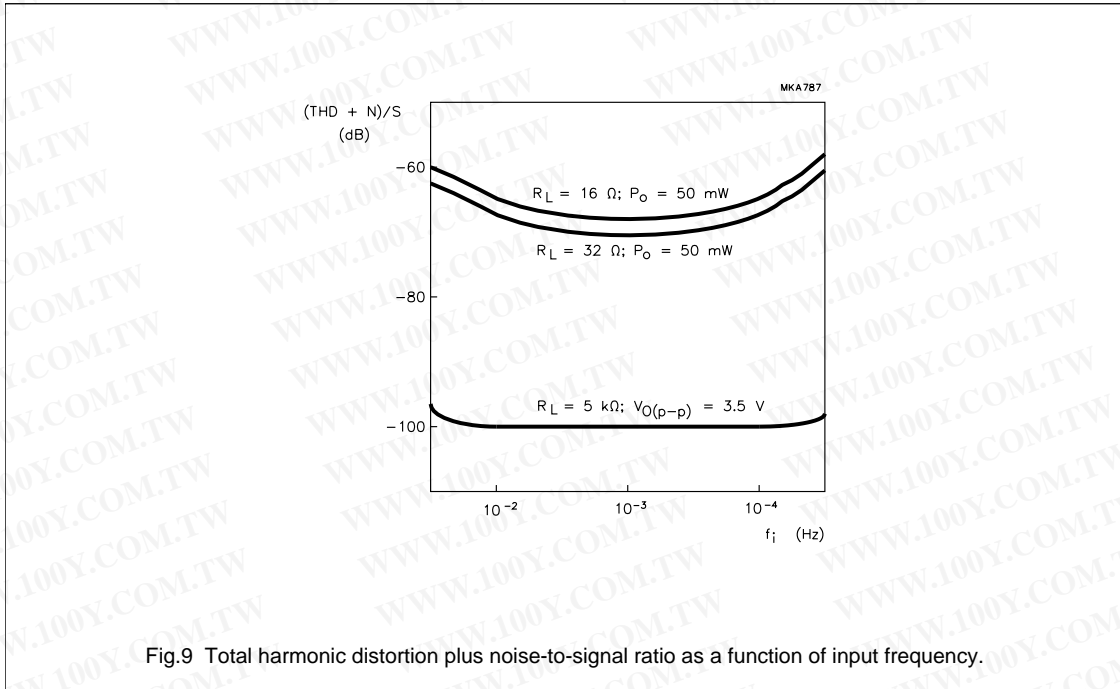
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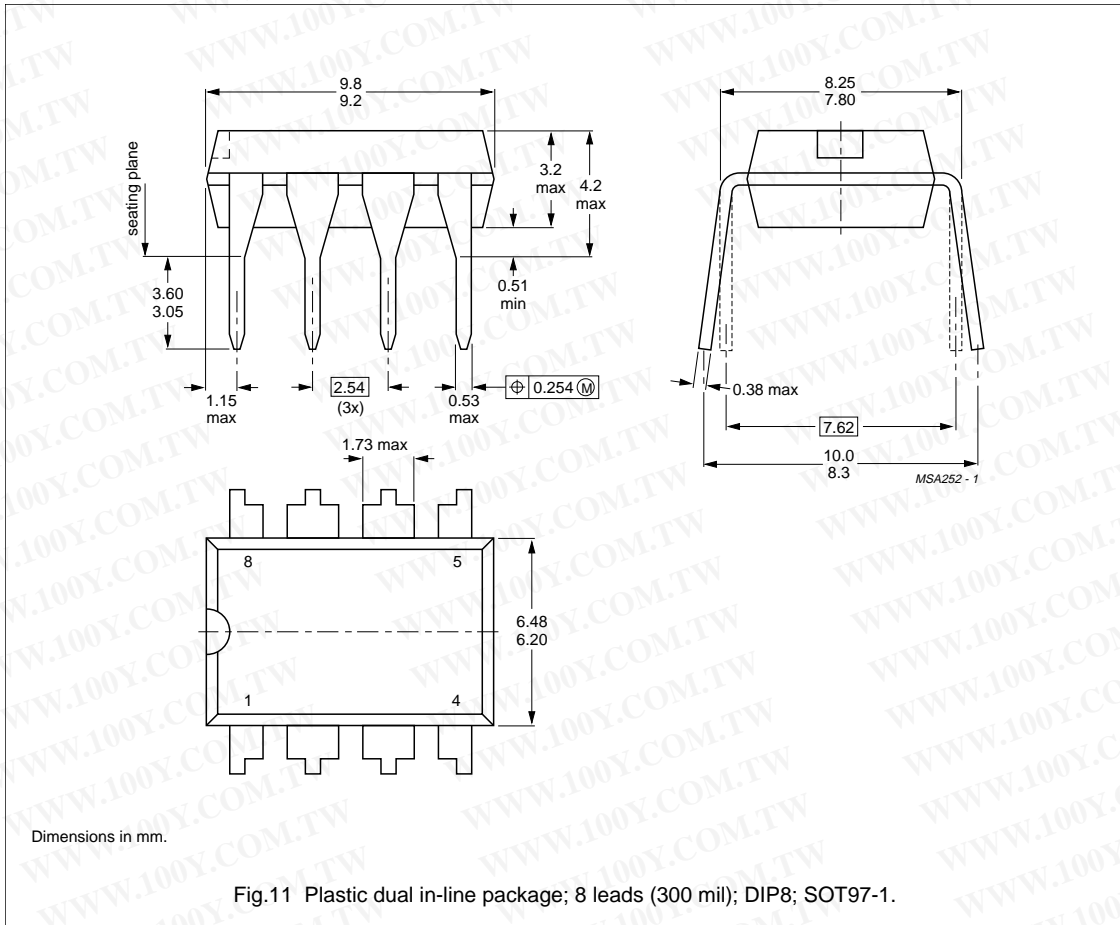
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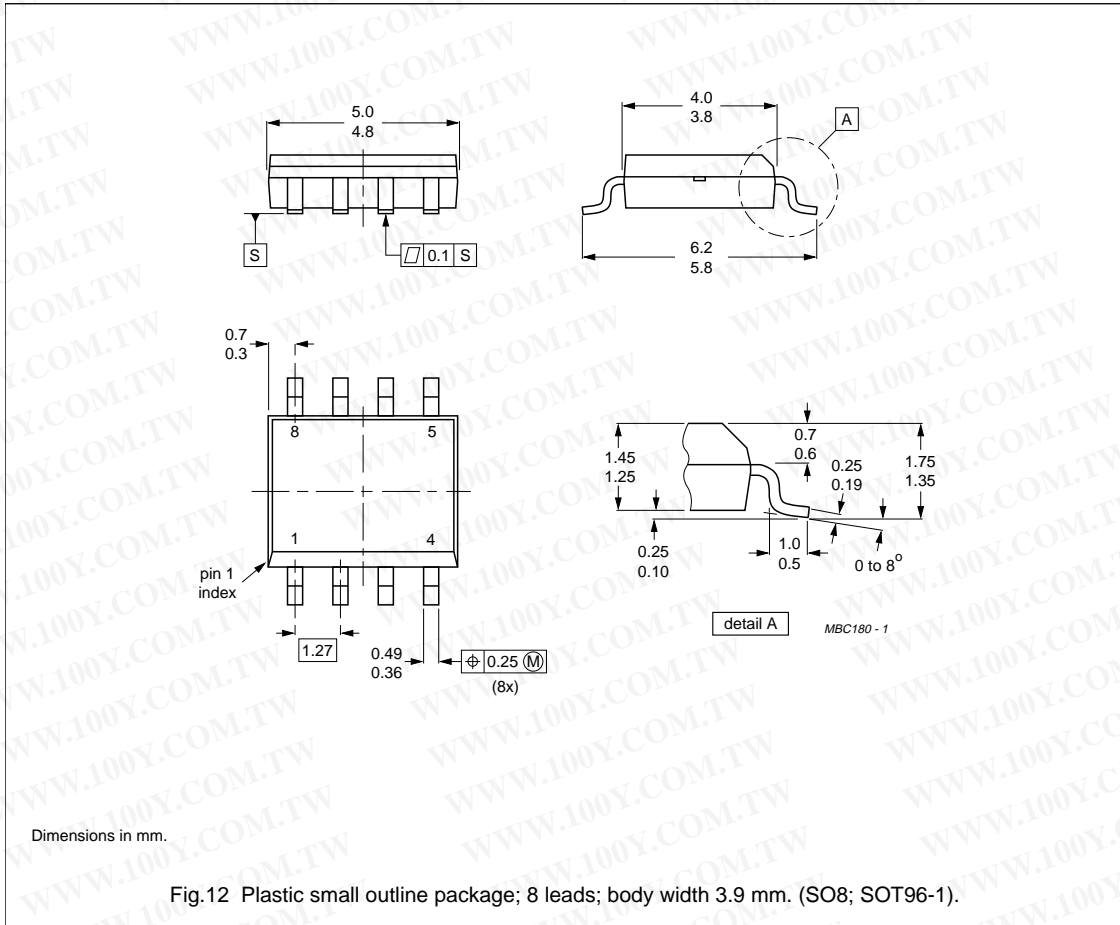
PACKAGE OUTLINES



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**Class AB stereo headphone driver****TDA1308****SOLDERING****Plastic dual in-line packages**

BY DIP OR WAVE

The maximum permissible temperature of the solder is 260 °C; this temperature must not be in contact with the joint for more than 5 s. The total contact time of successive solder waves must not exceed 5 s.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified storage maximum. If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

**REPAIRING SOLDERED JOINTS**

Apply the soldering iron below the seating plane (or not more than 2 mm above it). If its temperature is below 300 °C, it must not be in contact for more than 10 s; if between 300 and 400 °C, for not more than 5 s.

**Plastic small outline packages**

BY WAVE

During placement and before soldering, the component must be fixed with a droplet of adhesive. After curing the adhesive, the component can be soldered. The adhesive can be applied by screen printing, pin transfer or syringe dispensing.

Maximum permissible solder temperature is 260 °C, and maximum duration of package immersion in solder bath is 10 s, if allowed to cool to less than 150 °C within 6 s. Typical dwell time is 4 s at 250 °C.

A modified wave soldering technique is recommended using two solder waves (dual-wave), in which a turbulent wave with high upward pressure is followed by a smooth laminar wave. Using a mildly-activated flux eliminates the need for removal of corrosive residues in most applications.

**BY SOLDER PASTE REFLOW**

Reflow soldering requires the solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the substrate by screen printing, stencilling or pressure-syringe dispensing before device placement.

Several techniques exist for reflowing; for example, thermal conduction by heated belt, infrared, and vapour-phase reflow. Dwell times vary between 50 and 300 s according to method. Typical reflow temperatures range from 215 to 250 °C.

Preheating is necessary to dry the paste and evaporate the binding agent. Preheating duration: 45 min at 45 °C.

**REPAIRING SOLDERED JOINTS (BY HAND-HELD SOLDERING IRON OR PULSE-HEATED SOLDER TOOL)**

Fix the component by first soldering two, diagonally opposite, end pins. Apply the heating tool to the flat part of the pin only. Contact time must be limited to 10 s at up to 300 °C. When using proper tools, all other pins can be soldered in one operation within 2 to 5 s at between 270 and 320 °C. (Pulse-heated soldering is not recommended for SO packages.)

For pulse-heated solder tool (resistance) soldering of VSO packages, solder is applied to the substrate by dipping or by an extra thick tin/lead plating before package placement.

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**DEFINITIONS**

<b>Data sheet status</b>	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
<b>Limiting values</b>	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
<b>Application information</b>	
Where application information is given, it is advisory and does not form part of the specification.	

**LIFE SUPPORT APPLICATIONS**

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

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